



## UTT36N05

Preliminary

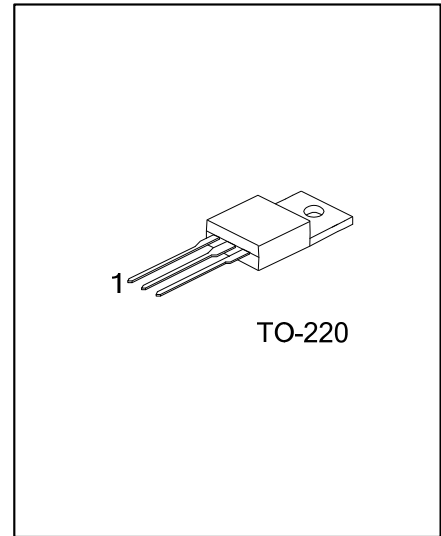
Power MOSFET

### 36A, 50V N-CHANNEL ENHANCEMENT MODE POWER MOSFET TRANSISTOR

#### DESCRIPTION

The UTC **UTT36N05** is an N-channel enhancement power MOSFET using UTC's advanced technology to provide the customers with perfect  $R_{DS(ON)}$ , high switching speed, high current capacity and low gate charge.

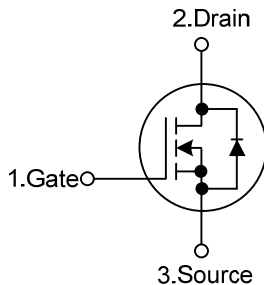
The UTC **UTT36N05** is suitable for motor control, AC-DC or DC-DC converters and audio amplifiers, etc.



#### FEATURES

- \*  $R_{DS(ON)}=33m\Omega @ V_{GS}=5V, I_D=18A$
- \* High Switching Speed
- \* High Current Capacity
- \* Low Gate Charge(typical 35nC)

#### SYMBOL



#### ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
UTT36N05L-TA3-T	UTT36N05G-TA3-T	TO-220	G	D	S	Tube

Note: Pin Assignment: G: Gate D: Drain S: Source

UTT36N05L-TA3-T 	(1) T: Tube (2) TA3: TO-220 (3) G: Halogen Free, L: Lead Free
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■ ABSOLUTE MAXIMUM RATINGS ( $T_C=25^\circ\text{C}$ , unless otherwise specified)

PARAMETER			SYMBOL	RATINGS	UNIT
Drain-Source Voltage ( $V_{GS}=0$ )			$V_{DSS}$	50	V
Drain-Gate Voltage ( $R_{GS}=20\text{k}\Omega$ )			$V_{DGR}$	50	V
Gate-Source Voltage			$V_{GSS}$	$\pm 15$	V
Drain Current	Continuous	$T_C=25^\circ\text{C}$	$I_D$	36	A
		$T_C=100^\circ\text{C}$		25	A
	Pulsed (Note 2)		$I_{DM}$	144	A
Avalanche Energy		Single Pulsed	$E_{AS}$	240	mJ
		Repetitive	$E_{AR}$	60	mJ
Power Dissipation ( $T_C=25^\circ\text{C}$ )			$P_D$	100	W
Junction Temperature			$T_J$	150	$^\circ\text{C}$
Storage Temperature			$T_{STG}$	-65~175	$^\circ\text{C}$

- Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.  
 Absolute maximum ratings are stress ratings only and functional device operation is not implied.  
 2. Pulse width limited by safe operating area

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	$\theta_{JA}$	62.5	$^\circ\text{C}/\text{W}$
Junction to Case	$\theta_{JC}$	1.25	$^\circ\text{C}/\text{W}$

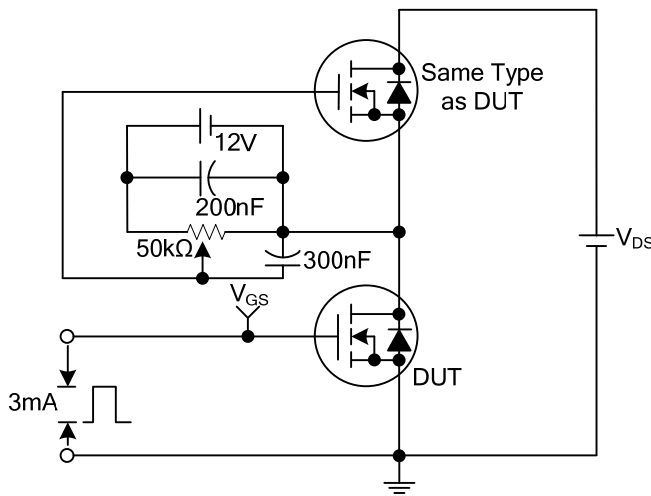
■ ELECTRICAL CHARACTERISTICS (T<sub>c</sub>=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
<b>OFF CHARACTERISTICS</b>							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	I <sub>D</sub> =250μA, V <sub>GS</sub> =0V	50			V	
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =Max Rating, V <sub>GS</sub> =0V			1	μA	
		V <sub>DS</sub> = Max ×0.8, T <sub>C</sub> =125°C, V <sub>GS</sub> =0V			10		
Gate- Source Leakage Current	Forward	I <sub>GSS</sub>				+100	
	Reverse					-100	
<b>ON CHARACTERISTICS (Note 1)</b>							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1	1.6	2.5	V	
Static Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =5V, I <sub>D</sub> =18A		0.033	0.04	Ω	
On State Drain Current	I <sub>D(ON)</sub>	V <sub>DS</sub> >I <sub>D(ON)</sub> ×R <sub>DS(ON)</sub> max, V <sub>GS</sub> =10V	36			A	
<b>DYNAMIC PARAMETERS</b>							
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1.0MHz		1350	1800	pF	
Output Capacitance	C <sub>OSS</sub>			450	600	pF	
Reverse Transfer Capacitance	C <sub>RSS</sub>			130	200	pF	
<b>SWITCHING PARAMETERS</b>							
Total Gate Charge	Q <sub>G</sub>	V <sub>GS</sub> =5V, V <sub>DS</sub> =40V, I <sub>D</sub> =36A		35	50	nC	
Gate to Source Charge	Q <sub>GS</sub>			11		nC	
Gate to Drain Charge	Q <sub>GD</sub>			19		nC	
Turn-ON Delay Time	t <sub>D(ON)</sub>	V <sub>DD</sub> =25V, I <sub>D</sub> =18A, R <sub>G</sub> =50Ω, V <sub>GS</sub> =5V		90	130	ns	
Rise Time	t <sub>R</sub>			550	800	ns	
OFF-Voltage Rise Time	t <sub>R(OFF)</sub>	V <sub>DD</sub> =40V, I <sub>D</sub> =36A, R <sub>G</sub> =50Ω, V <sub>GS</sub> =5V		110	160	ns	
Fall-Time	t <sub>F</sub>			180	260	ns	
Cross-Over Time	t <sub>C</sub>			310	450	ns	
<b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b>							
Maximum Body-Diode Continuous Current	I <sub>S</sub>				36	A	
Maximum Body-Diode Pulsed Current	I <sub>SM</sub>	(Note 2)			144	A	
Drain-Source Diode Forward Voltage	V <sub>SD</sub>	I <sub>SD</sub> =36A, V <sub>GS</sub> =0V (Note 1)			1.6	V	
Body Diode Reverse Recovery Time	t <sub>RR</sub>	I <sub>SD</sub> =36A, V <sub>DD</sub> =30V, di/dt=100A/μs, T <sub>J</sub> = 150°C		100		ns	
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>				0.27		μC
Body Diode Reverse Recovery Current	I <sub>RRM</sub>				5.5		A

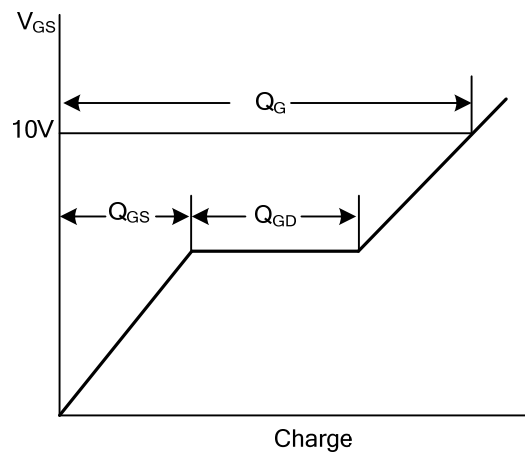
Notes: 1. Pulsed: Pulse duration = 300 ms, duty cycle 1.5%

2. Pulse width limited by safe operating area

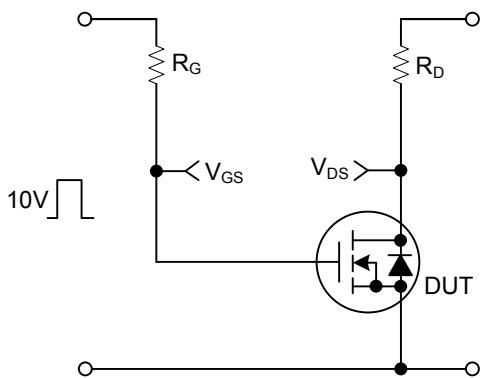
■ TEST CIRCUITS AND WAVEFORMS



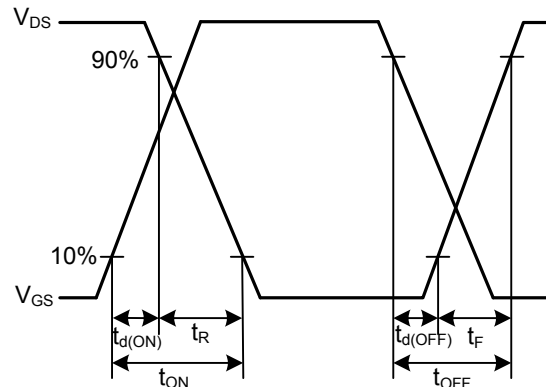
Gate Charge Test Circuit



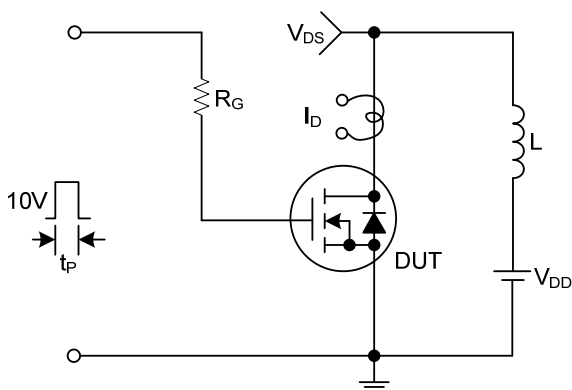
Gate Charge Waveforms



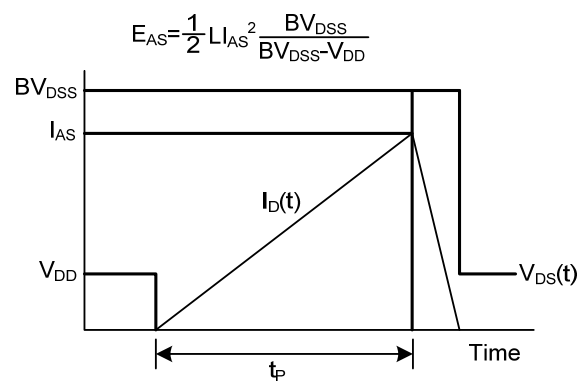
Resistive Switching Test Circuit



Resistive Switching Waveforms

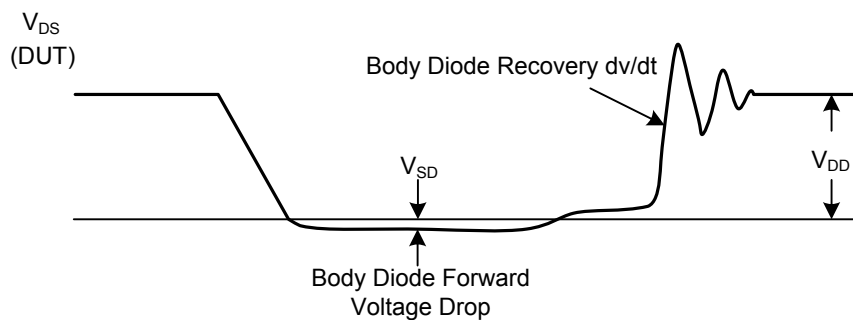
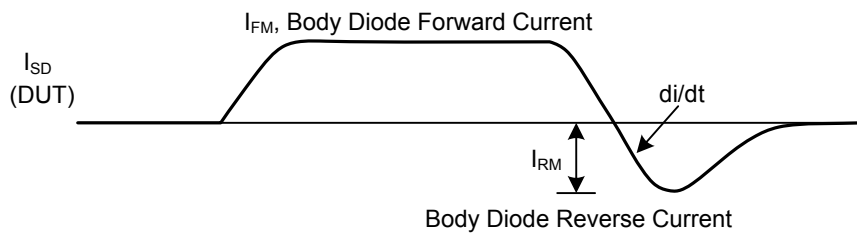
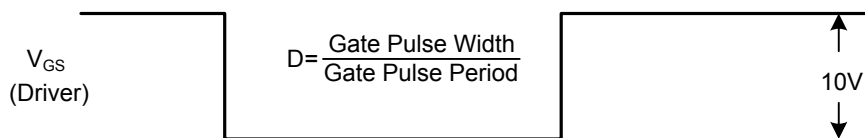
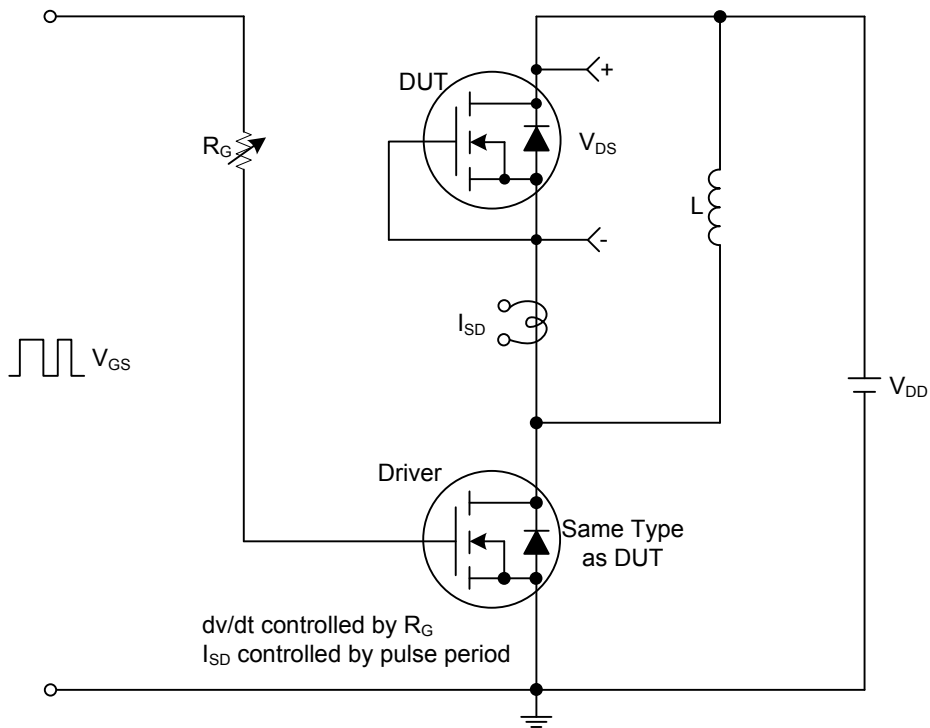


Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

■ TEST CIRCUITS AND WAVEFORMS(Cont.)



Peak Diode Recovery  $dv/dt$  Test Circuit and Waveforms

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